



### DISCRIPTION

# **FEATURES**

Ceramic Core High frequency design Excellent Q values Excellent SRF High reliability Excellent thermal stability

# **OPTIONS**

Tape & Reel is Standard (Qty: 3.000 Pcs) Bulk Packing Available for smaller quantites Tolerance: J = 5% and K=10% is Standard, tighter Tolerance available (MOQ on request)

### **APPLICATIONS**

Modems Mobile Radios Cordless Telephones Global Positioning Systems Telecommunications Systems

# **PHYSICAL CHARACTERISTICS**

- Testing : (Equivalents acceptable) Inductance & Q-HP4191A + HP4291A SRF : HP8553B ; RDC : 25°C
- Operating Temperature : Ceramic -55°C ~ 125°C
- Pad metalization : Tungsten-nickel with gold flash
- Solder methods : Wave, Reflow, Vapor Phase
- Solderability : Max 260°C for 10 seconds
- Marking : EIA color code

#### **ELECTRICAL SPECIFICATIONS**

Properties	Test conditions		Value	Unit	Tol.
Inductance		L	10,0	nH	see Site 2
Q factor		Q	40		min.
DC-resistance		DCR typ.		Ω	typ.
DC-resistance		DCR max.	0,080	Ω	max.
Self-Res. Freq.		SRF	4000	Mhz	min.
Test-Freq.			1000	Mhz	
Rated Current		IDC	1000	mA	max.
Saturation Current		Isat		mA	typ.

<ol> <li>This electronic component is meant to be used in general electronic equipment. Before the incorporation of this component into any equipment with higher and more reliable requirements such as aviation, aerospace, submarine, nuclear control, transportation, transportation signal, disaster prevention, medical public information network, etc. or if there is a possibility of injuries or damages to the human body, Edco</li> </ol>					h as aviation, vention, medical,	SMT WIF CERAI INDU	CHIP	
-Components must be informed before the stage of design-in. Evaluation checks for safety have to be performed on each electronic components used in electrical circuits that require high safety and reliability				Part No.:	S12005-10N			
functions.					Customer:			
DRW:	Chang	CHKD	Young	MATL:	Chu Chi	DATE		09.06.2009
APPD:	Pong			FINISH	Vienna	Sheet		1 from 2

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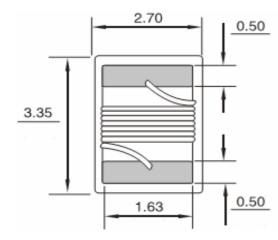
email: info@edcon-components.com

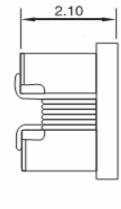


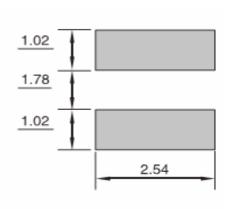


## **TECHNICAL INFORMATIONS**

#### Dimensions (mm)



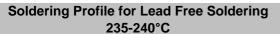


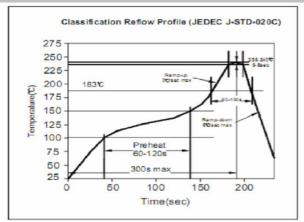


**Ordering Information** 

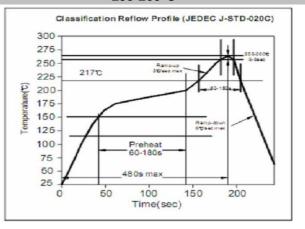
Serie and Range S12005-10N

Tolerance	ROHS	Packing			
K	P	тр			
K	R	TR			
<b>J</b> = 5%	<b>R</b> = ROHS	BU = Bulk Ware			
<b>K</b> = 10%	N = non ROHS	TR = Tape Reel			
<b>M</b> = 20%					
<b>N</b> = 30%					





Soldering Profile for Lead Free Soldering 255-260°C



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					Part No.: <b>\$12005-10N</b>			
functions.					Customer:			
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